

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5304823

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JYH-CHYANG TZOU	01/02/2019
YAO-HSIEN YANG	01/02/2019
YI-HSUN LIU	01/02/2019
HSIAO-WEN TSENG	01/02/2019
CHENG-YA CHI	01/02/2019
RECEIVING PARTY DATA	
Name:	COMPAL ELECTRONICS, INC.
Street Address:	NO. 581 & 581-1, RUIGUANG RD., NEIHU DISTRICT,
City:	TAIPEI CITY
State/Country:	TAIWAN
Postal Code:	11492
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16237751
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	01/02/2019
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,

1.Jyh-Chyang Tzou
3.Yi-Hsun Liu
5.Cheng-Ya Chi

2.Yao-Hsien Yang
4.Hsiao-Wen Tseng

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **ELECTRONIC DEVICE, HINGE ASSEMBLY AND AUGMENTED REALITY
INTERACTION PROCESS FOR ELECTRONIC DEVICE**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, 1. **COMPAL ELECTRONICS, INC.**
of No. 581 & 581-1, Ruiguang Rd., Neihu District, Taipei City
11492, Taiwan (R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: JYH-CHYANG Tzou Date: JAN 02 2019

Sole or First Joint Inventor: Jyh-Chyang Tzou

Signature: YAO-HSIEN YANG Date: JAN 02 2019

Second Joint Inventor (if any): Yao-Hsien Yang

Signature: Yi Hsun Liu Date: JAN 02 2019

Third Joint Inventor (if any): Yi-Hsun Liu

Signature: Hsiao-Wen Tseng Date: JAN 02 2019

Fourth Joint Inventor (if any): Hsiao-Wen Tseng

Signature: Cheng-Ya Chi Date: JAN 02 2019

Fifth Joint Inventor (if any): Cheng-Ya Chi